

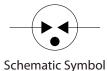
FEATURES

1	Surface	Mounting	Design	5.4*5.4*5.0mm
	Junace	mounting	Design	J.+ J.+ J.0IIIIII

- High Current Handling Capability 5000A @ 8/20 µs
- Low Capacitance and Insertion Loss
- Quick Response and Long Service Life
- Moisture sensitivity level: Level 1



5.4*5.4*5.0mm



APPLICATION INFORMATION

Communication equipment.

- Repeaters,Modems
- Telephone Interface,Line cards.

Data communication equipment.

AGENCY APPROVALS

lcon	Solderability		
RoHS	Compliance with 2011/65/EU		
HF Compliance with IEC61249-2-21:2003			
Pb	Mean lead free		
19.	L Certificated E505857		

PRODUCT CHARACTERISTICS

Lead Material	Body Material	Terminal Finish
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated



ELECTRICAL PARAMETER

Parameter	Condition	Rating	Unit
DC Spark-over Voltage 1)	100V/s	280-420	
Impulse Spark-over Voltage	At 1kV/μs	for 99 % of measured values ≤1000	V
impulse spark-over voltage	At 1kV/µs	Typical values of distribution ≤950	
Discharge Current (8/20us) 2)	10 times	5	KA
AC Discharge Current	50Hz, 1S	5	А
Minimum Insulation Resistance	Test Voltage DC=100V	1	GΩ
Max. Capacitance 1MHz	V _{DC} =0.5V	1	pF
Operating and Storage Temperature		-40~125	°C

1) In ionized mode

2) Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21

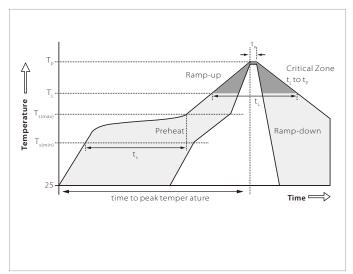
ENVIRONMENTAL RELIABILITY CHARACTERISTICS

Testing items	Technical standards	
High Temperature Storage Test Temperature: 85°C ; Time:2H		
Low Temperature Storage Test	Temperature: -40°C ; Time:2H	
Vibration	Frequency: 10-500Hz ; Amplitude: 0.15mm ; Time:45min	
Resistance of soldering heat	Temperature: 260±5°C; Time of dip soldering: 10s, 1time	

NOTE: Up-screen program can be specified by customer's request via contacting Semiware service

REFLOW PROFILE

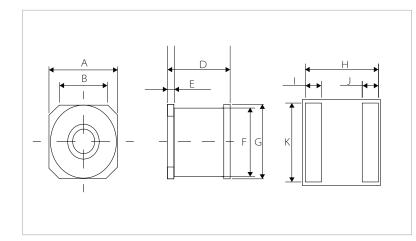
	Reflow Condition	Lead-free assembly	
	Temperature Min	150°C	
Pre Heat	Temperature Max	200°C	
	Time(min to max)	60-180 secs	
Average ra	amp up rate (Liquidus)Temp (T_L) to peak T_s (max)to T_L - Ramp-up Rate	3°C/second max	
Deflering	Temperature (T _L) (Liquidus)	217°C	
Reflow	Temperature (T _L)	60-150 seconds	
PeakTem	perature (T _p)	245~260 °C	
Time with	in 5°C of actual peak Temperature (tp)	30 seconds	
Ramp-dc	own Rate	6°C/second max	
Time 25°0	C to peak Temperature (T _p)	8 minutes max.	
Do not exceed		260°C	





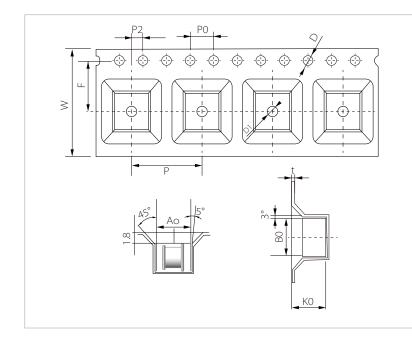


DIMENSIONS AND RECOMMENDED SOLDERING PAD



Ref.	mm
A	5.4±0.1
В	3.8
D	5.0±0.2
E	0.5±0.1
F	Φ5.0±0.1
G	Ф5.4±0.1
Н	5.7
I	1.2
J	1.2
K	5.8

PACKAGE REEL INFORMATION



Ref.	mm
W	16.0±0.3
Ρ	12.0±0.1
F	7.5±0.1
P2	2.0±0.1
D	1.5±0.1
D1	1.5±0.1
PO	4.0±0.1
10P0	40.0±0.2
AO	5.7±0.1
ВО	5.7±0.1
КО	5.7±0.1
t	0.4±0.05

ORDERING INFORMATION

Part Number	Size	Marking	QTY/Reel	Reel Size
SG2R05B350A	5.4*5.4*5.0mm	🕢 SG350 <u>05</u>	800	13″



Headquarters

No.3387 Shendu Road Pujiang I&E Park Minhang Shanghai China 201000

Hotline 400-021-5756

Web Https://www.semiware.com

Sales center

Tel: 86-21-3463-7458 Email: sales18@semiware.com

Customer Service

Tel: 86-21-5484-1001 Email: sales17@semiware.com

Technical Support

Tel: 86-21-3463-7654 Email: fae01@semiware.com

Complaint & Suggestions

Tel: 86-21-3463-7172 Ext: 8868 Email: cs03@semiware.com

By QR Code





Website

Wechat

To find your local partner within Semiware's global network: www.semiware.com (2) 2022 Semiware Semiconductor Inc.

The content of this document has been carefully checked and understood. However, neither Semiware nor its subsidiaries assume any liability whatsoever for any errors or inaccuracies of this document and theconsequences thereof. Published specifications are subject to change without notice. Product suitability for any area of application must ultimately be determined by the customer. In all cases, products must never be operated outside their published specifications. Semiware does not guarantee the availability of all published products. This disclaimer shall be governed by substantive Chinese law and resulting disputes shall be settled by the courts at the place of business of Semiware. Latest publications and a complete disclaimer can be downloaded from the Semiware website. All trademarks recognized.